

ICS 31.200
CCS L 55



**NATIONAL STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

GB/T 19248-2003

**Test method for measuring the resistance of package leads
(English Translation)**

Issued on: July 2, 2003

Implemented on: October 1, 2003

**Issued by: General Administration of Quality Supervision, Inspection and
Quarantine of the People Republic of China**

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What this standard covers

This standard specifies the package lead resistance measurement method. This standard applies to pin grid array package (PGA) test lead resistance. The testing technique is also applicable to other microelectronic packaging, such as leadless chip carrier (LCC), four sides lead flat package (QFP) and ceramic dual in- package (CDIP) and other test lead resistance.

Document data

International classification (ICS): 31.200.

Chinese classification (CCS): L55.

Estimated length of the Chinese original: 2,297 words.

Adopted international standard: SEMI G25-1989, MOD.